

SAMXON BRAND ALUMINUM ELECTROLYTIC CAPACITORS **PRODUCT SPECIFICATION**



CUSTOMER:

DATE :2019-5-13

(客戶):

(日期):

CATEGORY (品名)	: ALUMINUM ELECTROLYTIC CAPACITORS
DESCRIPTION (型号)	: GF 25V470μF(φ10x16)
VERSION (版本)	: 01
Customer P/N	:
SUPPLIER	:

SUPPI	LIER	CUSTO	OMER
PREPARED (拟定)	CHECKED (审核)	OVAL :准)	SIGNATURE (签名)
赵安平	刘渭清		

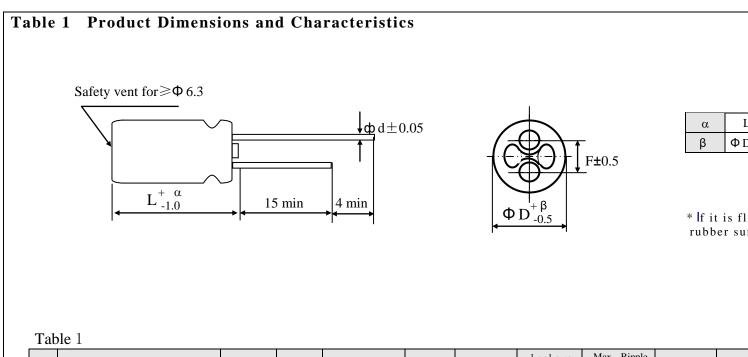
ELECTROLYTIC CAPACITOR SPECIFICATION GF SERIES

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	Approver

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N o		SAMXON Part No.	WV (Vdc)	Cap. (µF)	Cap. tolerance	Temp. range (°C)	tan ð (120Hz, 20°C)	Leakage Current (µA,2mi n)	Max Ripple Current at 105°C 100kHz (mA rms)	Impedance at 20°C 100kHz (Ωmax)	Lo: lifeti (Hı
	1	EGF477M1EG16RR**P	25	470	-20%~+20%	-40 ~105	0.14	118	1210	0.060	30

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Application 1.

This specification applies to polar Aluminum electrolytic capacitor (foil type) used in electronic equipment. Designed capacitor's quality meets IEC60384. **Part Number System**

2.

1 2	3 4	5 6	5 7]	89	[10 11 12	2 131	14	1516	17
EGS	S 1	0 5	5 M		1 H		D 1 1	— т (С	SA	Ρ
SERIES	CAPA	CITAN	CE TOI		VOLTAGE		CASE SIZE	TYP		SAMXON	SLEEVE
			I						1	PRODUCT LINE	
Series	Cap(MFD)	Code	Tolerance (%)	Code	Voltage (W.V.)	Code	Case Size	Feature (Code	SAMXON Product	Line
ESM	0.1	104			2	0D	Diameter(Radial bulk	RR	For internal use onl	
EKF ESS	0.1	104	±5	J	2.5	0E	35 1			(The product lines	
EKS EGS	0.22	224			6.3	0G 0J	4 C 5 D	Ammo Tap	ing	we have H,A,B,C,D	
EKM			±10	к	8	05 0K	6.3 E 8 F	O Course Ditate		E,M or 0,1,2,3,4,5,9	"
EKG EOM	0.33	334			10	1A	10 G	2.0mm Pitch	TT		II
EZM EZS	0.47	474	±15	L	12.5	1B	12.5 I 13 J	2.5mm Pitch	TU	_	
EGF					16	10	13.5 V 14 4				
ESF EGT	1	105	±20	м	20 25	1D 1E	14.5 A	3.5mm Pitch	11	Sleeve Material	Code
EGK					30	11	14.5 A 16 K 16.5 7	5.0mm Pitch	тс	PET	Р
EGD	2.2	225	±30	N	32	13	10 1	0.011111101	ĽŬ		
EGC	3.3	335	-40	14/	35	1V	20 M	Lead Cut & I	Form		
ERF			Ő	w	40	1G	22 N 25 O	CP Torr		PVC	If the
ERR	4.7	475	-20	_	42	1M	25 O 30 P 34 W	СВ-Туре	СВ		the sleeve material is
ERT	40	100	0	A	50 57	1H 1L	34 VV 35 Q	CE-Type	CE		90V6
ERD	10	106	-20	с	63	1L 1J	40 R 42 4				ma
EBD	22	226	+10	C	71	15	45 6 51 S	HE-Type	HE		teria
ERA			-20	x	75	1 T	63.5 T	KD-Type	10		al is
ERC	33	336	+40		80	1K	76 U 80 8	KD-Type	KD		PVC,
EFA	47	470	-20	s	85	1R	90 X 100 Z	FD-Type	FD		
ERW	47	476	+50		90	19 2A	Len.(mm) Code		\vdash		there will
ERY	100	107	-10 0	в	120	20	4.5 45 5 05	EH-Type	EH		≦
EAP					125	2B	5.4 54 7 07	DOD Town	ui al		be
EQP	220	227	-10 +20	v	150	2Z	7.7 77	PCB Term	na		blan
EDP ETP		007			160	2C	10.2 T2 11 11		sw		i i i
EHP	330	337	-10 +30	Q	180	2P	11.5 1A		\vdash		Sev
EKP	470	477	-10		200 215	2D 22	12 12 12.5 1B	Snap-in	sx		be blank in seventeenth digit
EEP			+50	Т	215	2N	13 13 13.5 1C		sz		ent
ESP EVP	2200	228	-5	Е	230	23	20 20 25 25		52		ļ ģ.
EGP	22000	222	+10		250	2E	20 20 25 25 29.5 2J	Lug	SG		7÷
EWR	22000	229	-5 +15	F	275	2T	30 30				
EWT	33000	339			300	21	31.5 3A 35 35		05		
EWX			+20	G	310 315	2R 2F	35.5 3E		06		
EWS EWH	47000	479	0		330	20	50 50 80 80 100 1L				
EWL	100000	107	+20	R	350	2V	105 1K		Т5		
EWB VSS	100000	10T		0	360	2X	110 1M 120 1N	Screw			
VNS VKS	150000	15T	+30		375	2Q	130 1P		Т6		
VKM			+50	I	385	2Y	140 1Q 150 1R		D5		
VRL VNH	220000	22T	+5	-	400	2G 2M	155 1E 160 1S				
VZS	330000	33Т	+15	z	420	2W	165 1F		D6		
VRF	330000	331	+5	D	500	2H	165 1F 170 1T 180 1U				
	1000000	10M	+20		550	25	190 1V 200 2L 215 2A				
			+10 +50	Y	600	26	215 2A				
	1500000	15M	+10		630	2J	210 2M 220 2N				
	2200000	22M	+30	н			210 2M 220 2N 240 2Q 250 2R				
	3300000	33M					260 2S 270 2T				
		00101									

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Sleeve

Separator

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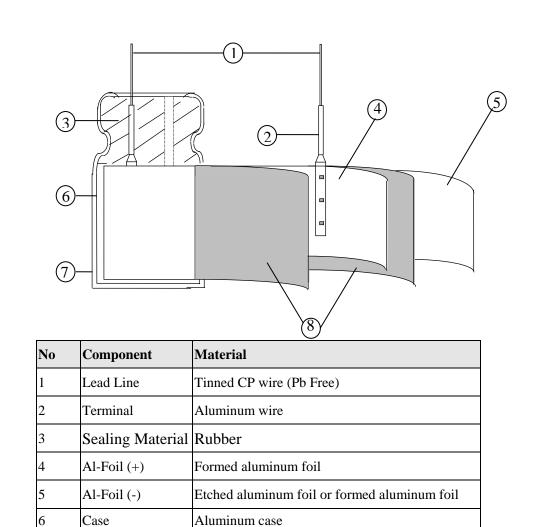
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3. Construction

Single ended type to be produced to fix the terminals to anode and cathode foil, and wind together with paper, and then wound element to be impregnated with electrolyte will be enclosed in an aluminum case. Finally sealed up tightly with end seal rubber, then finished by putting on the vinyl sleeve.



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PVC/PET

Electrolyte paper

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4. Characteristics

Standard atmospheric conditions

Unless otherwise specified, the standard range of atmospheric conditions for making measurements and tests is as follows:

Ambient temperature	:15°C to 35°C
Relative humidity	: 45% to 85%
Air Pressure	: 86kPa to 106kPa

If there is any doubt about the results, measurement shall be made within the following conditions:Ambient temperature: $20^{\circ}C \pm 2^{\circ}C$ Relative humidity: 60% to 70%Air Pressure: 86kPa to 106kPa

Operating temperature range

The ambient temperature range at which the capacitor can be operated continuously at rated voltage See table 1 temperature range.

As to the detailed information, please refer to table 2

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able 2	ITEM			PE	RFORM	ANCE			
	Rated voltage (WV)	WV (V.DC) SV (V.DC)	6.3 8	10 13	16 20	25 32	35 44	50 63	63 79
4.1	Surge voltage (SV)	WV (V.DC) SV (V.DC)	100 125]					
4.2	Nominal capacitance (Tolerance)	<condition> Measuring Fro Measuring Vo Measuring Te <criteria> Shall be within</criteria></condition>	ltage mperatur	: Not e : 20±	more than 2℃	n 0.5Vrms	5		
4.3	Leakage current	<condition> Connecting the minutes, and the Criteria> Refer to Table</condition>	nen, meas				$(1k\Omega \pm$	10Ω) in	series for a
4.4	tanδ	< Condition> See 4.2, Norm < Criteria> Refer to Table		nnce, for 1	neasuring	; frequenc	y, voltage	e and tem	perature.
4.5	5 Impedance <condition> Measuring frequency:100kHz; Measuring temperature:20±2°C Measuring point: 2mm max. from the surface of a sealing rubber on the lead wire. <criteria> Refer to Table 1</criteria></condition>								

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4.6	Terminal strength	<condition> Tensile Strength of Terminals Fixed the capacitor, applied force to the terminal in lead out direction for ± 1 seconds. Bending Strength of Terminals Fixed the capacitor, applied force to bent the terminal (1~4 mm from rubber) for 90° within 2~3 seconds, and then bent it for 90° to its origi position within 2~3 seconds.Diameter of lead wireTensile force N (kgf)Bending force N (kgf)0.5mm and less5 (0.51)2.5 (0.25)Over 0.5mm to 0.8mm10 (1.0)5 (0.51)Criteria> No noticeable changes shall be found, no breakage or looseness at terminal.</br></condition>						
4.7	Temperature characteristic	STEP Testing Temperature(°C) Time 1 20±2 Time to reach thermal equilibrium 2 -40(-25) ±3 Time to reach thermal equilibrium 3 20±2 Time to reach thermal equilibrium 4 105±2 Time to reach thermal equilibrium 5 20±2 Time to reach thermal equilibrium 6 20±2 Time to reach thermal equilibrium 5 20±2 Time to reach thermal equilibrium 6 105±2 Time to reach thermal equilibrium 6 20±2 Time to reach thermal equilibrium 6 105±2 Time to reach thermal equilibrium 7 20±2 Time to reach thermal equilibrium 8 tanð shall be within the limit of Item 4.4 The leakage current measured shall not more than 8 times of its specified value. 9. In step 5, tanð shall be within the limit of Item 4.4 The leakage current shall not more than the specified value						

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4.7

4.8

Load

life test

Shelf

4.9

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b.	At-40°C (-25°C), impeda	nce (Z) ra	tio shall n	ot exceed	l the value	e of the fo	llowing ta	ıble.					
	Working Voltage (V)	6.3	10	16	25	35	50						
	Z-25°C/Z+20°C	4	3	2	2	2	2						
	Z-40°C/Z+20°C 8 6 4 3 3 3												
				-									
	Working Voltage (V) 63 100												
	Z-25°C/Z+20°C 2 2												
	Z-40°C/Z+20°C 3 3												
	Capacitance, $tan\delta$, and impedance shall be measured at 120Hz.												
<condition></condition>													
	According to IEC6038	4-4No.4.1	3 method	ls, The ca	pacitor is	stored at	a						
	temperature of 105 °C :	± 2 with I	OC bias v	oltage plu	is the rate	ed ripple o	current for	ſ					
	2000 10/0/ - D - F -	(0)	2000	10/0 /									

d ripple current for te 2000+48/0(φ D,φ 5~φ 6.3) hours , 3000+48/0 (φ D,φ 8~φ 10) hours, 4000+48/0 (ϕ D $\geq \phi$ 12.5) hours. (The sum of DC and ripple peak voltage shall not exceed the rated working voltage) Then the product should be tested after 16 hours recovering time at atmospheric conditions. The result should meet the following table:

<criteria> The characteristic shall meet the following requirements.</criteria>					
Leakage current	Value in 4.3 shall be satisfied				
Capacitance Change	Within $\pm 25\%$ of initial value.				
tanδ	Not more than 150% of the specified value.				
Appearance	There shall be no leakage of electrolyte.				

<Condition> The capacitors are then stored with no voltage applied at a temperature of 105 ± 2 °C for 1000+48/0 hours. Following this period the capacitors shall be removed from the test chamber and be

allowed to stabilized at room temperature for 4~8 hours. Next they shall be connected to a series limiting resistor($1k \pm 100\Omega$) with D.C. rated voltage applied for 30min. After which the capacitors shall be discharged, and then, tested the characteristics. <Criteria>

life The characteristic shall meet the following requirements. test

Value in 4.3 shall be satisfied Leakage current Within $\pm 25\%$ of initial value. **Capacitance** Change tanδ Not more than 150% of the specified value. Appearance There shall be no leakage of electrolyte.

Remark: If the capacitors are stored more than 1 year, the leakage current may

increase. Please apply voltage through about 1 k Ω resistor, if necessary.

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	1	
4.10	Surge test	<condition> Applied a surge voltage to the capacitor connected with a (100 ±50)/C_R (kΩ) resistor. The capacitor shall be submitted to 1000 cycles, each consisting of charge of 30 ±5s, followed discharge of 5 min 30s. The test temperature shall be 15~35°C. C_R :Nominal Capacitance (μ F) Criteria> Leakage current Not more than the specified value. Capacitance Change Within ±15% of initial value. tanð Not more than the specified value. Appearance There shall be no leakage of electrolyte. Attention: This test simulates over voltage at abnormal situation only. It is not applicable to such over voltage as often applied.</condition>
4.11	Vibration test	<condition> The following conditions shall be applied for 2 hours in each 3 mutually perpendicular directions. Vibration frequency range : 10Hz ~ 55Hz Peak to peak amplitude : 1.5mm Sweep rate : 10Hz ~ 55Hz ~ 10Hz in about 1 minute Mounting method: The capacitor with diameter greater than 12.5mm or longer than 25mm must be fixed in place with a bracket. 4mm or less 4mm or less To be soldered</condition>

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After the test, the following items shall be tested:Inner constructionNo intermittent contacts, open or short circuiting. No damage of tab terminals or electrodes.AppearanceNo mechanical damage in terminal. No leakage of electrolyte or swelling of the case. The markings shall be legible.4.12Solderability test4.12Solderability testCondition> The capacitor shall be tested under the following conditions: Soldering temperature Dipping depth Est2.5mm/s Dipping time4.13Solderability testCondition> Terminals of the capacitor shall be immersed into solder bath at 260 ± 5 °C for 10 ± 1 seconds or 400 ± 10 °C for 3 $^{-1}_{-0}$ seconds to 1.5~2.0mm from the body of capacitor . Then the capacitor shall be left under the normal temperature and normal humidity for 1~2 hours before measurement.4.13Resistance to solder heat test4.13Resistance to solder heat testAnal testNot more than the specified value. Capacitance Change Within ± 10% of initial value. tanð Not more than the specified value. Capacitance Change Within ± 10% of initial value. tanð Not more than the specified value. Capacitance Change Within ± 10% of initial value. tanð Not more than the specified value. Capacitance Change Within ± 10% of initial value. there shall be no leakage of electrolyte.			<criteria></criteria>	
4.12 Solderability Condition> 4.13 Resistance to solder heat test Accondition > Inter capacitor shall be test of the capacitor shall be immersed into solder bath at 260 \pm 5 °C for 10 \pm 1 seconds or 400 \pm 10 °C for 3 $\frac{1}{-0}$ seconds to 1.5~2.0mm from the body of capacitor . 4.13 Resistance to solder heat test Not more than the specified value. 4.13 Resistance to solder heat test Not more than the specified value. 4.13 Resistance to solder heat test Not more than the specified value.			After the test, the follow	
Appearance of electrolyte or swelling of the case. The markings shall be legible. 4.12 Condition> The capacitor shall be tested under the following conditions: Soldering temperature $: 245\pm3^{\circ}C$ Dipping depth $: 2mm$ Dipping speed $: 25\pm2.5mm/s$ Dipping time $: 3\pm0.5s$ 4.12 Solderability test Criteria> Coating quality A minimum of 95% of the surface being immersed 4.13 Resistance to solder heat test Criteria> Criteria> Corticria> Corticria> Criteria> Corticria> Corticria> Condition > Terminals of the capacitor shall be immersed into solder bath at $260\pm5^{\circ}C$ for 10 ± 1 seconds or $400\pm10^{\circ}C$ for 3^{+1}_{-0} seconds to 1.5 -2.0mm from the body of capacitor . Then the capacitor shall be left under the normal temperature and normal humidity for 1~2 hours before measurement. 4.13 Resistance to solder heat test Criteria> Criteria> Criteria> Criteria> Criteria> Criteria> Comparence			Inner construction	circuiting. No damage of tab terminals or
4.12 Resistance to 4.13 Resistance to 4.13 Resistance to 4.13 Resistance to 4.13 Resistance to 4.14 Resistance to 4.15 Resistance to 4.15 Resistance to 4.16 Resistance to 4.16 Resistance to 4.17 Resistance to 4.18 Resistance to 4.19 Resistance to 4.10			Appearance	of electrolyte or swelling of the case.
4.12Soldering temperature $: 245\pm3^{\circ}C$ Dipping depth4.12Solderability test $: 25\pm2.5mm/s$ Dipping time4.13Solderability test $< Criteria>$ Coating quality4.13Resistance to solder heat test $< Criteria>$ Criteria> Coating quality4.13Resistance to solder heat test $< Criteria>$ Ceriteria> Terminals of the capacitor shall be immersed into solder bath at $260\pm5^{\circ}C$ for 10 ± 1 seconds or $400\pm10^{\circ}C$ for 3^{+1}_{-0} seconds to $1.5\sim2.0mm$ from the body of capacitor . Then the capacitor shall be left under the normal temperature and normal humidity for $1\sim2$ hours before measurement.4.13Resistance to solder heat test $< Criteria>$ Leakage current Capacitance Change There shall be no leakage of				
4.12 Dipping depth : 2mm Solderability : $25\pm 2.5 \text{ mm/s}$ bipping speed : $3\pm 0.5 \text{ s}$ Coating quality A minimum of 95% of the surface being immersed Coating quality A minimum of 95% of the surface being immersed Condition> Terminals of the capacitor shall be immersed into solder bath at $260 \pm 5 ^\circ \text{C}$ for $10 \pm 1 \text{ seconds or } 400 \pm 10 ^\circ \text{C}$ for 3^{+1}_{-0} seconds to $1.5 \sim 2.0 \text{mm}$ from the body of capacitor . Then the capacitor shall be left under the normal temperature and normal humidity for $1 \sim 2$ hours before measurement. 4.13 Resistance to solder heat test Leakage current Not more than the specified value. Capacitance Change Within $\pm 10\%$ of initial value. $\tan \delta$ Not more than the specified value.			The capacitor shall be tes	ted under the following conditions:
4.12 Solderability test Dipping speed : 25 ± 2.5 mm/s Dipping time : 3 ± 0.5 s 4.12 Solderability test Coating quality A minimum of 95% of the surface being immersed (Condition> Condition> Terminals of the capacitor shall be immersed into solder bath at 260 ± 5 °C for 10 ± 1 seconds or 400 ± 10 °C for 3^{+1}_{-0} seconds to $1.5 \sim 2.0$ mm from the body of capacitor . 4.13 Resistance to solder heat test Criteria> 4.13 Resistance to solder heat test Criteria> 4.13 Resistance to solder heat test Not more than the specified value. (Capacitance Change Within $\pm 10\%$ of initial value. (and) Not more than the specified value. (Amearance There shall be no leakage of			Soldering temperature	: 245±3°C
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4.13 Resistance to solder heat test $< \frac{<\text{Condition>}}{\text{Condition}}$ < Condition> Terminals of the capacitor shall be immersed into solder bath at $260 \pm 5 ^{\circ}\text{C} \text{ for } 10 \pm 1 \text{ seconds or } 400 \pm 10 ^{\circ}\text{C} \text{ for } 3^{+1}_{-0} \text{ seconds to } 1.5 \sim 2.0 \text{mm}}$ from the body of capacitor . Then the capacitor shall be left under the normal temperature and normal humidity for $1 \sim 2$ hours before measurement. $< \frac{\text{Criteria>}}{\text{Leakage current}} \text{ Not more than the specified value.}$ $\text{Capacitance Change}$ Within $\pm 10\%$ of initial value. $\frac{\tan \delta}{\text{Annearance}}$ There shall be no leakage of		test		
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4.13humidity for 1~2 hours before measurement.4.13Resistance to solder heat testCriteria>Leakage currentNot more than the specified value.Capacitance ChangeWithin $\pm 10\%$ of initial value.tan δ Not more than the specified value.AppearanceThere shall be no leakage of			Terminals of the capacito	
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testCapacitance ChangeWithin $\pm 10\%$ of initial value. $\tan \delta$ Not more than the specified value. Δ prearanceThere shall be no leakage of			Terminals of the capacito 260 ± 5 °C for 10 ± 1 second from the body of capacitor Then the capacitor shall humidity for 1~2 hours b	and s or 400 ± 10 °C for 3 $^{+1}_{-0}$ seconds to 1.5~2.0mm for . be left under the normal temperature and normal
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Annearance	4.13	solder heat	Terminals of the capacito 260 ± 5 °C for 10 ± 1 second from the body of capacitor Then the capacitor shall humidity for 1~2 hours by Criteria > Leakage current Capacitance Change	and so 400 ± 10 °C for 3^{+1}_{-0} seconds to $1.5 \sim 2.0$ mm for . be left under the normal temperature and normal before measurement. Not more than the specified value. Within $\pm 10\%$ of initial value.
	4.13	solder heat	Terminals of the capacito 260 ± 5 °C for 10 ± 1 second from the body of capacitor Then the capacitor shall humidity for 1~2 hours by Criteria > Leakage current Capacitance Change	ands or 400 ± 10 °C for3 $^{+1}_{-0}$ seconds to 1.5~2.0mm for . be left under the normal temperature and normal before measurement. Not more than the specified value. Within $\pm 10\%$ of initial value. Not more than the specified value.
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		<condition> Temperature Cycle: According to IEC6038 oven, the condition ac</condition>		pacitor shall be placed in a	ın
		Те	mperature	Time	
		(1)+20°C		≤ 3 Minutes	
		(2)Rated low tempera	ature(-40°C)(-25°C)	30 ± 2 Minutes	
		(3)Rated high temper	rature $(+105^{\circ}C)$	30 ± 2 Minutes	
	Change of	(1) to (3)=1 cycle, tot	tal 5 cycle		
4.14	temperature test	< Criteria > The characteristic shall Leakage current tanδ Appearance	Not more than theNot more than the	specified value.	
4.15	Damp heat test	<condition> Humidity Test: According to IEC60384 be exposed for 500±8 40±2°C, the characteri <criteria> Leakage current Capacitance Change tanδ Appearance</criteria></condition>	hours in an atmosphere stic change shall meet Not more than the spe Within $\pm 20\%$ of init	e of 90~95%R H .at the following requirement. ecified value. tial value. of the specified value.	-

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4.16Vent testD.C. test The capacitor is connected with its polarity reversed to a DC power source. The a current selected from below table is applied. $(22.4 \text{ or less} 1)$ 4.16Vent test $(2180 - 3)$ $(22.4 \text{ or less} 1)$ Criteria> The vent shall operate with no dangerous conditions such as flames or dispersion of pieces of the capacitor and/or case.Condition> The maximum permissible ripple current is the maximum A.C current at 100kHz and can be applied at maximum operating temperature Table-1 The combined value of D.C voltage and the peak A.C voltage shall not exceed the rated voltage and shall not reverse voltage.4.17Maximum permissible (ripple current)Frequency Multipliers: $(Hz) (Hz) (Hz) (Hz) (Hz) (Hz) (Hz) (Hz) $			Condition> The following test only appl $\geq \emptyset 6.3$ with vent.	y to those	products w	ith vent pr	oducts at d	iameter
4.16Vent testDiameter (mm) 22.4 or less DC Current (A) 22.4 or less 4.16 $arriversizeCriteria>The vent shall operate with no dangerous conditions such as flames or dispersionof pieces of the capacitor and/or case.Condition>The maximum permissible ripple current is the maximum A.C currentat 100kHz and can be applied at maximum operating temperatureTable-1The combined value of D.C voltage and the peak A.C voltage shall not exceed therated voltage and shall not reverse voltage.4.17Maximum(ripple(ripplecurrent)Frequency Multipliers:Coefficient(Hz)The local(Hz)4.17Maximum(ripplecurrent)Frequency Multipliers:(Altiplice)The local(Altiplice)4.17Maximum(ripplecurrent)Freq.(Hz)1201k100k(220~5600.500.850.941.00(0.00)(2200~39002200~39000.750.900.951.00$			The capacitor is connected w			d to a DC p	oower sourc	e. Then
4.17 Maximum permissible (ripple current) A.17 Maximum permissible A.17 Maximum permissible A.17 Maximum permissible A.17 Maximum permissible (ripple current) A.17 Maximum A.17	4.16		Diameter (mm) DC Curr					
4.17 Maximum permissible (ripple current) A.17 (ripple current) A.17 (ripple current) A.100 (rip			The vent shall operate with n		us condition	is such as fl	ames or dis	persion
$4.17 \begin{array}{ c c c c c c c c c c c c c c c c c c c$			The maximum permissible rip at 100kHz and can be applied Table-1 The combined value of D.C w rated voltage and shall not re	d at maxim voltage and	um operatii the peak A	ng temperat	ture	eed the
4.17 (ripple current) ~180 0.40 0.75 0.90 1.00 220~560 0.50 0.85 0.94 1.00 680~1800 0.60 0.87 0.95 1.00 2200~3900 0.75 0.90 0.95 1.00			Coefficient Freq. (Hz)	120	1k	10k	100k	
680~1800 0.60 0.87 0.95 1.00 2200~3900 0.75 0.90 0.95 1.00	4.17	(ripple	~180	0.40	0.75	0.90	1.00	
2200~3900 0.75 0.90 0.95 1.00		current)						
			4700	0.85	0.95	0.98	1.00]

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5. List of "Environment-related Substances to be Controlled ('Controlled Substances')"

The latest version of <Substances Prohibited as per Sony-SS-00259>

	Substances			
	Cadmium and cadmium compounds			
Heavy metals	Lead and lead compounds			
Theavy metals	Mercury and mercury compounds			
	Hexavalent chromium compounds			
	Polychlorinated biphenyls (PCB)			
Chloinated	Polychlorinated naphthalenes (PCN)			
organic	Polychlorinated terphenyls (PCT)			
compounds	Short-chain chlorinated paraffins(SCCP)			
	Other chlorinated organic compounds			
Duraniastal	Polybrominated biphenyls (PBB)			
Brominated organic	Polybrominated diphenylethers(PBDE) (including decabromodiphenyl			
	ether[DecaBDE])			
compounds	Other brominated organic compounds			
Tributyltin comp	ounds(TBT)			
Triphenyltin con	npounds(TPT)			
Asbestos				
Specific azo com	pounds			
Formaldehyde				
Beryllium oxide				
Beryllium copp	er			
Specific phthalat	es (DEHP,DBP,BBP,DINP,DIDP,DNOP,DNHP)			
Hydrofluorocarb	on (HFC), Perfluorocarbon (PFC)			
Perfluorooctane	sulfonates (PFOS)			
Specific Benzotr	iazole			

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Attachment: Application Guidelines

1.Circuit Design

1.1 Operating Temperature and Frequency

Electrolytic capacitor electrical parameters are normally specified at 20° C temperature and 120Hz frequency. These parameters vary with changes in temperature and frequency. Circuit designers should take these changes into consideration.

- (1) Effects of operating temperature on electrical parameters
 - a) At higher temperatures, leakage current and capacitance increase while equivalent series resistance (ESR) decreases.
 - b) At lower temperatures, leakage current and capacitance decrease while equivalent series resistance (ESR) increases.
- (2) Effects of frequency on electrical parameters
 - a) At higher frequencies capacitance and impedance decrease while $tan\delta$ increases.
 - b) At lower frequencies, ripple current generated heat will rise due to an increase in equivalent series resistance (ESR).
- 1.2 Operating Temperature and Life Expectancy See the file: Life calculation of aluminum electrolytic capacitor
- 1.3 Common Application Conditions to Avoid

The following misapplication load conditions will cause rapid deterioration to capacitor electrical parameters. In addition, rapid heating and gas generation within the capacitor can occur causing the pressure relief vent to operate and resultant leakage of electrolyte. Under Leaking electrolyte is combustible and electrically conductive.

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(1) Reverse Voltage

DC capacitors have polarity. Verify correct polarity before insertion. For circuits with changing or uncertain polarity, use DC bipolar capacitors. DC bipolar capacitors are not suitable for use in AC circuits.

(2) Charge / Discharge Applications

Standard capacitors are not suitable for use in repeating charge / discharge applications. For charge / discharge applications consult us and advise actual conditions.

(3) Over voltage

Do not apply voltages exceeding the maximum specified rated voltage. Voltages up to the surge voltage rating are acceptable for short periods of time. Ensure that the sum of the DC voltage and the superimposed AC ripple voltage does not exceed the rated voltage.

(4) Ripple Current

Do not apply ripple currents exceeding the maximum specified value. For high ripple current applications, use a capacitor designed for high ripple currents or contact us with your requirements. Ensure that allowable ripple currents superimposed on low DC bias voltages do not cause reverse voltage conditions.

- 1.4 Using Two or More Capacitors in Series or Parallel
- (1) Capacitors Connected in Parallel

The circuit resistance can closely approximate the series resistance of the capacitor causing an imbalance of ripple current loads within the capacitors. Careful design of wiring methods can minimize the possibility of excessive ripple currents applied to a capacitor.

(2) Capacitors Connected in Series

Normal DC leakage current differences among capacitors can cause voltage imbalances. The use of voltage divider shunt resistors with consideration to leakage current can prevent capacitor voltage imbalances.

- 1.5 Capacitor Mounting Considerations
- (1) Double Sided Circuit Boards

Avoid wiring pattern runs, which pass between the mounted capacitor and the circuit board. When dipping into a solder bath, excess solder may collect under the capacitor by capillary action and short circuit the anode and cathode terminals.

(2)Circuit Board Hole Positioning

The vinyl sleeve of the capacitor can be damaged if solder passes through a lead hole for subsequently processed parts. Special care when locating hole positions in proximity to capacitors is recommended.

(3)Circuit Board Hole Spacing

The circuit board holes spacing should match the capacitor lead wire spacing within the specified tolerances. Incorrect spacing can cause excessive lead wire stress during the insertion process. This may result in premature capacitor failure due to short or open circuit, increased leakage current, or electrolyte leakage.

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 (4) Clearance for Case Mounted Pressure Relief vents Capacitors with case mounted pressure relief vents require sufficient clearance to allow for proper vent operation. The minimum clearances are dependent on capacitor diameters as proper vent operation. The minimum clearances are dependent on capacitor diameters as follows. φ 6.3~φ 16mm:2mm minimum, φ 18~φ 35mm:3mm minimum, φ 40mm or greater:5mm minimum.
φ 0.5 φ rommer greater sinn minimum, φ ro φ seministration minimum, φ rommer greater sinn minimum.
(5) Clearance for Seal Mounted Pressure Relief Vents A hole in the circuit board directly under the seal vent location is required to allow proper release of pressure.
(6) Wiring Near the Pressure Relief Vent Avoid locating high voltage or high current wiring or circuit board paths above the pressure relief vent. Flammable, high temperature gas exceeding 100°C may be released which could dissolve the wire insulation and ignite.
(7) Circuit Board patterns Under the Capacitor Avoid circuit board runs under the capacitor as electrolyte leakage could cause an electrical short.
(8) Screw Terminal Capacitor Mounting Do not orient the capacitor with the screw terminal side of the capacitor facing downwards. Tighten the terminal and mounting bracket screws within the torque range specified in the specification.
 1.6 Electrical Isolation of the Capacitor Completely isolate the capacitor as follows. (1) Between the cathode and the case (except for axially leaded B types) and between the anode terminal and other circuit paths (2) Between the avtra mounting terminals (on T types) and the anode terminal, actual terminal, and other aircuit
(2) Between the extra mounting terminals (on T types) and the anode terminal, cathode terminal, and other circuit paths.
1.7 The Product endurance should take the sample as the standard.
 1.8 If conduct the load or shelf life test, must be collect date code within 6 months products of sampling. 1.9 Capacitor Sleeve
The vinyl sleeve or laminate coating is intended for marking and identification purposes and is not meant to electrically insulate the capacitor.
The sleeve may split or crack if immersed into solvents such as toluene or xylene, and then exposed to high temperatures.
CAUTION! Always consider safety when designing equipment and circuits. Plan for worst case failure modes such as short circuits and open circuits which could occur during use. (1) Provide protection circuits and protection devices to allow safe failure modes. (2) Design redundant or secondary circuits where possible to assure continued operation in case of main circuit failure.

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2.Capacitor Handling Techniques

- 2.1 Considerations Before Using
- (1) Capacitors have a finite life. Do not reuse or recycle capacitors from used equipment.
- (2) Transient recovery voltage may be generated in the capacitor due to dielectric absorption. If required, this voltage can be discharged with a resistor with a value of about $1k\Omega$.
- (3) Capacitors stored for long periods of time may exhibit an increase in leakage current. This can be corrected by gradually applying rated voltage in series with a resistor of approximately $1k\Omega$.
- (4) If capacitors are dropped, they can be damaged mechanically or electrically. Avoid using dropped capacitors.
- (5) Dented or crushed capacitors should not be used. The seal integrity can be compromised and loss of electrolyte / shortened life can result.

2.2 Capacitor Insertion

- * (1) Verify the correct capacitance and rated voltage of the capacitor.
- * (2) Verify the correct polarity of the capacitor before inserting.
- * (3) Verify the correct hole spacing before insertion (land pattern size on chip type) to avoid stress on the terminals.
 - (4) Ensure that the auto insertion equipment lead clinching operation does not stress the capacitor leads where they enter the seal of the capacitor.

For chip type capacitors, excessive mounting pressure can cause high leakage current, short circuit, or disconnection.

2.3 Manual Soldering

- (1) Observe temperature and time soldering specifications or do not exceed temperatures of 400 $^{\circ}$ C for 3 seconds or less.
- (2) If lead wires must be formed to meet terminal board hole spacing, avoid stress on the lead wire where it enters the capacitor seal.
- (3) If a soldered capacitor must be removed and reinserted, avoid excessive stress to the capacitor leads.
- (4) Avoid touching the tip of the soldering iron to the capacitor, to prevent melting of the vinyl sleeve.

2.4 Flow Soldering

- (1) Do not immerse the capacitor body into the solder bath as excessive internal pressure could result.
- (2) Observe proper soldering conditions (temperature, time, etc.) Do not exceed the specified limits.
- (3) Do not allow other parts or components to touch the capacitor during soldering.

2.5 Other Soldering Considerations

Rapid temperature rises during the preheat operation and resin bonding operation can cause cracking of the capacitor vinyl sleeve.

For heat curing, do not exceed 150° C for a maximum time of 2 minutes.

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2.6 Capacitor Handling after Solder

- (1). Avoid movement of the capacitor after soldering to prevent excessive stress on the lead wires where they enter the seal.
- (2). Do not use capacitor as a handle when moving the circuit board assembly.
- (3). Avoid striking the capacitor after assembly to prevent failure due to excessive shock.

2.7 Circuit Board Cleaning

- * (1) Circuit boards can be immersed or ultrasonically cleaned using suitable cleaning solvents for up 5 minutes and up to 60° C maximum temperatures. The boards should be thoroughly rinsed and dried.
- The use of ozone depleting cleaning agents is not recommended in the interest of protecting the environment.
- * (2) Avoid using the following solvent groups unless specifically allowed for in the specification;
- Halogenated cleaning solvents: except for solvent resistant capacitor types, halogenated solvents can permeate the seal and cause internal capacitor corrosion and failure. For solvent resistant capacitors, carefully follow the temperature and time requirements of the specification. 1-1-1 trichloroethane should never be used on any aluminum electrolytic capacitor.
- Alkali solvents : could attack and dissolve the aluminum case.
- Petroleum based solvents: deterioration of the rubber seal could result.
- . Xylene : deterioration of the rubber seal could result.
- Acetone : removal of the ink markings on the vinyl sleeve could result.
- * (3) A thorough drying after cleaning is required to remove residual cleaning solvents which may be trapped between the capacitor and the circuit board. Avoid drying temperatures, which exceed the maximum rated temperature of the capacitor.
- * (4) Monitor the contamination levels of the cleaning solvents during use by electrical conductivity, pH, specific gravity, or water content. Chlorine levels can rise with contamination and adversely affect the performance of the capacitor.

Please consult us for additional information about acceptable cleaning solvents or cleaning methods.

2.8 Mounting Adhesives and Coating Agents

When using mounting adhesives or coating agents to control humidity, avoid using materials containing halogenated solvents. Also, avoid the use of chloroprene based polymers.

After applying adhesives or coatings, dry thoroughly to prevent residual solvents from being trapped between the capacitor and the circuit board.

3. Precautions for using capacitors

3.1 Environmental Conditions

- Capacitors should not be stored or used in the following environments.
- * (1) Temperature exposure above the maximum rated or below the minimum rated temperature of the capacitor.
- * (2) Direct contact with water, salt water, or oil.
- * (3) High humidity conditions where water could condense on the capacitor.

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- * (4) Exposure to toxic gases such as hydrogen sulfide, sulfuric acid, nitric acid chlorine, or ammonia.
- * (5) Exposure to ozone, radiation, or ultraviolet rays.
- * (6) Vibration and shock conditions exceeding specified requirements.

3.2 Electrical Precautions

- (1) Avoid touching the terminals of the capacitor as possible electric shock could result. The exposed aluminum case is not insulated and could also cause electric shock if touched.
- (2) Avoid short circuit the area between the capacitor terminals with conductive materials including liquids such as acids or alkaline solutions.

4. Emergency Procedures

- (1) If the pressure relief vent of the capacitor operates, immediately turn off the equipment and disconnect form the power source. This will minimize additional damage caused by the vaporizing electrolyte.
- (2) Avoid contact with the escaping electrolyte gas which can exceed 100°C temperatures. If electrolyte or gas enters the eye, immediately flush the eyes with large amounts of water. If electrolyte or gas is ingested by month, gargle with water. If electrolyte contacts the skin, wash with soap and water.

5. Long Term Storage

Leakage current of a capacitor increases with long storage times. The aluminum oxide film deteriorates as a function of temperature and time. If used without reconditioning, an abnormally high current will be required to restore the oxide film. This current surge could cause the circuit or the capacitor to fail.

After one year, a capacitor should be reconditioned by applying rated voltage in series with a 1000Ω , current limiting resistor for a time period of 30 minutes .

- If the expired date of products date code is over eighteen months, the products should be return to confirmation. 5.1 Environmental Conditions
 - The capacitor shall be not use in the following condition:
 - (1) Temperature exposure above the maximum rated or below the minimum rated temperature of the capacitor.
 - (2) Direct contact with water, salt water, or oil.
 - (3) High humidity conditions where water could condense on the capacitor.
 - (4) Exposure to toxic gases such as hydrogen sulfide, sulfuric acid, nitric acid, chlorine, or ammonia.
 - (5) Exposure to ozone, radiation, or ultraviolet rays.
 - (6) Vibration and shock conditions exceeding specified requirements.

6. Capacitor Disposal

- When disposing of capacitors, use one of the following methods.
- * Incinerate after crushing the capacitor or puncturing the can wall (to prevent explosion due to internal pressure rise). Capacitors should be incinerated at high temperatures to prevent the release of toxic gases such as chlorine from the polyvinyl chloride sleeve, etc.
- * Dispose of as solid waste.
 - NOTE: Local laws may have specific disposal requirements, which must be followed.

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